

N-Channel MOSFET

Description

The PNMDP200V9 is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in switching power supplies and adaptors.

MOSFET Product Summary				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	$I_D(A)$		
200	0.36 @ V _{GS} = 10V	9.0		

Feature

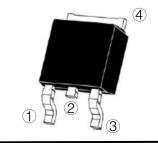
- > Fast switching capability
- > Avalanche energy tested
- Improved dv/dt capability, high ruggedness

Mechanical data

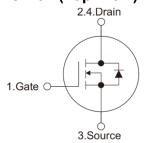
Case: TO-252

> Approx. Weight: 0.315g (0.011oz)

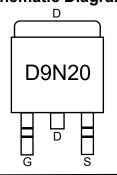
- > Lead free finish, RoHS compliant
- Case Material: "Green" molding compound, UL flammability classification 94V-0, "Halogen-free".
- > Device meets MSL 1 requirements



TO-252 (Top View)



Schematic Diagram



Marking (Top View)

Absolute maximum rating@25°C

Rating	Symbol	Value	Units
Drain-Source Voltage	V _{DS}	200	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous $ \frac{T_c=25^{\circ}C}{T_c=100^{\circ}C} $	I _D	9.0 5.2	Α
Pulsed Drain Current ²⁾	I _{DM}	36	А
Avalanche Energy, Single Pulsed ³⁾	E _{AS}	180	mJ
Peak Diode Recovery dv/dt ⁴⁾	dv/dt	2.1	V/ns
Maximum Power Dissipation	P_{D}	54	W
Operating Junction and Storage Temperature Range	T_J, T_STG	-55 ~ +150	°C
Junction-to-Ambient	$R_{ heta JA}$	63	°C/W
Junction to Case	$R_{ heta JC}$	2.31	°C/W

Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	$V_{GS} = 0V, I_{D} = 250 \mu A$	200	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 200V,V _{GS} = 0V	-	-	120	nA	
Gate-Body Leakage Current	I _{GSS}	$V_{GS} = \pm 20 V, V_{DS} = 0 V$	-	-	±100	nA	
On Characteristics							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.8	-	2.0	V	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} = 10V,I _D = 4.5A	-	0.36	0.4	Ω	
Dynamic Characteristics							
Input Capacitance	C _{lss}		-	1000	-		
Output Capacitance	C _{oss}	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz	-	90	-	pF	
Reverse Transfer Capacitance	C _{rss}		-	12	-		
Switching Characteristics							
Turn-on Delay Time ⁵⁾	t _{d(on)}		-	35	-		
Turn-on Rise Time	t _r	$V_{DS} = 100V, V_{GS} = 10V,$	-	20	-	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D = 9.0A, R_G = 20\Omega^{5,6}$	-	16.5	-		
Turn-Off Fall Time	t _f		-	35	-		
Total Gate Charge ⁵⁾	Q_g		-	31	-		
Gate-Source Charge	Q_{gs}	$V_{DS} = 160V, V_{GS} = 10V,$ $I_{D} = 9.0A, I_{G} = 1mA^{5,6}$	-	3.3	-	nC	
Gate-Drain Charge	Q_{gd}	, G	-	16.5	-		
Drain-Source Diode Characteristics							
Diode Forward Voltage ⁵⁾	V _{SD}	$V_{GS} = 0V, I_{S} = 9.0A$	-	-	1.4	V	
Diode Continuous Current	I _s		-	-	9.0	Α	
Diode Pulsed Current	I _{SM}		-	-	36	Α	
Reverse Recovery Time ⁵⁾	t _{rr}	$V_{GS} = 0V, I_{S} = 9.0A,$	-	370	-	nS	
Reverse Recovery Charge	Q _{rr}	di/dt = 100A/μs	-	0.95	-	μC	

^{1.}Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

^{2.} Repetitive Rating: Pulse width limited by maximum junction temperature. 3. L = 1mH, I_{AS} = 3.4A, V_{DD} = 50V, R_{G} = 20 Ω , Starting T_{J} = 25°C 4. I_{SD} ≤ 9A, di/dt ≤ 200A/ μ s, V_{DD} ≤ BV $_{DSS}$, Starting T_{J} = 25°C 5. Pulse Test: Pulse width ≤ 300 μ s, Duty cycle ≤ 2%.

^{6.} Essentially independent of operating temperature.

Typical Characteristics

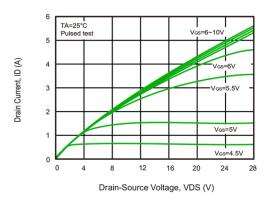


Fig.1 Drain Current vs. Gate-Source Voltage

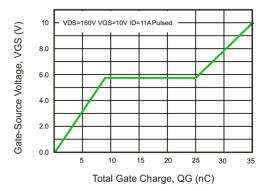


Fig.3 Gate Charge Characteristics

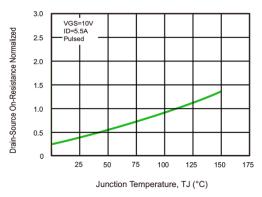


Fig.5 Drain-Source On-Resistance vs. Junction Temperature

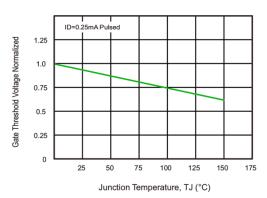


Fig.7 Gate Threshold Voltage vs. Junction Temperature

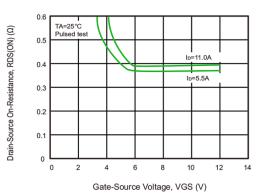


Fig.2 Drain-Source On-Resistance vs. Gate-Source Voltage

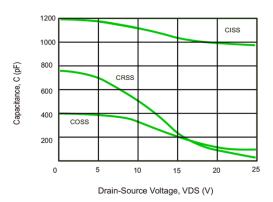


Fig.4 Capacitance Characteristics

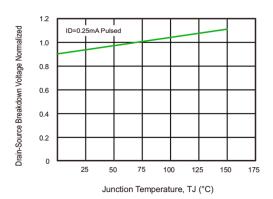


Fig.6 Breakdown Voltage vs. Junction Temperature

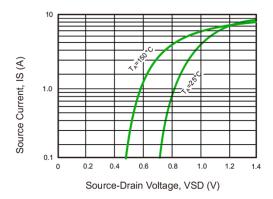


Fig.8 Source Current vs. Source-Drain Voltage

PNMDP200V9

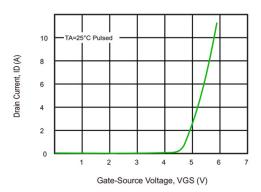


Fig.9 Drain Current vs. Gate-Source Voltage

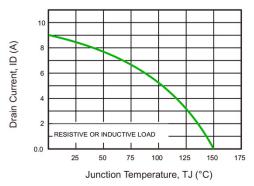


Fig.11 Drain Current vs. Junction Temperature

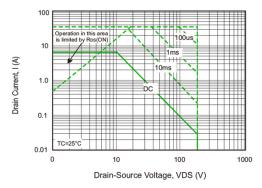


Fig.13 Safe Operating Area

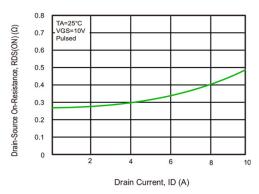


Fig.10 Drain-Source On-Resistance vs. Drain Current

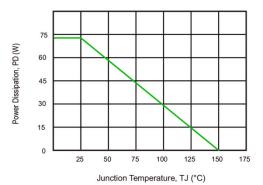
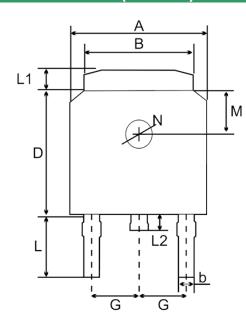
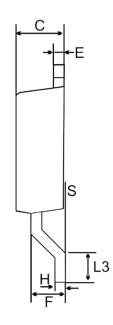
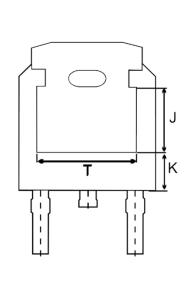


Fig.12 Power Dissipation vs. Junction Temperature

Product dimension (TO-252)







Div	Millimeters		Inc	hes	
Dim	Min	Max	Min	Max	
А	6.30	6.70	0.248	0.264	
В	5.10	5.50	0.201	0.217	
b	0.30	0.80	0.012	0.031	
С	2.10	2.50	0.083	0.098	
D	5.90	6.30	0.232	0.248	
Е	0.40	0.60	0.016	0.024	
F	1.30	1.80	0.051	0.071	
G	2.29 Typ.		0.090 Typ.		
Н	0.45	0.55	0.018	0.022	
L	2.70	3.10	0.106	0.122	
L1	0.80	1.20	0.031	0.047	
L2	0.60	1.00	0.024	0.039	
L3	1.00	1.75	0.039	0.069	
S	0.00	0.23	0.000	0.009	
М	1.80 Typ.		0.071 Typ.		
N	1.30 Typ.		0.051 Typ.		
J	3.16 Ref.		0.124 Ref.		
K	1.80 Ref.		0.071 Ref.		
Т	4.83 Ref.		0.190 Ref.		

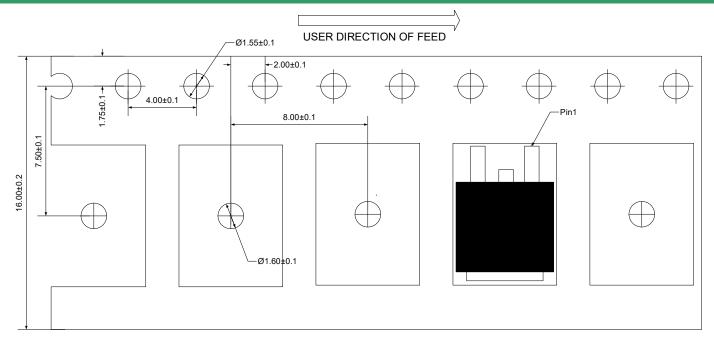
N-Channel MOSFET

PNMDP200V9

Ordering Information

Device	Package	Reel	Shipping
PNMDP200V9	To-252	13"	2500 / Tape & Reel

Load With Information



Unit:mm

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